



Growth of *b*-axis oriented VO₂ thin films on glass substrates using ZnO buffer layer

Te-Wei Chiu^{b,*}, Kazuhiko Tonooka^a, Naoto Kikuchi^a

^a Nanoelectronics Research Institute, National Institute of Advanced Industrial Science and Technology (AIST) AIST Tsukuba Central 2, 1-1-1 Umezono, Tsukuba, Ibaraki 305-8568, Japan

^b Department of Materials and Mineral Resources Engineering, National Taipei University of Technology, 1, Sec. 3, Zhongxiao E. Rd., Taipei, 106, Taiwan

ARTICLE INFO

Article history:

Received 17 January 2010

Received in revised form 18 March 2010

Accepted 23 April 2010

Available online 23 May 2010

Keywords:

VO₂

ZnO

Buffer layer

b-Axis

Preferential orientation

ABSTRACT

VO₂ thin films are grown on glass substrates by pulsed laser deposition using vanadium metal as a target. In this study, a ZnO thin film was used as a buffer layer for the growth of VO₂ thin films on glass substrates. X-ray diffraction studies showed that the VO₂ thin film had *b*-axis preferential orientation on a *c*-axis oriented ZnO buffer layer. The thickness of the ZnO buffer layer and the oxygen pressure during VO₂ deposition were optimized to grow highly *b*-axis oriented VO₂ thin films. The metal-insulator transition properties of the VO₂ film samples were investigated in terms of infrared reflectance and electrical resistance with varying temperatures.

© 2010 Elsevier B.V. All rights reserved.

1. Introduction

Past studies have reported that vanadium dioxide (VO₂) has a thermally induced semiconductor-to-metal transition at 341 K, accompanied by a structural change [1]. Below this transition temperature, VO₂ is a narrow gap (0.7 eV) semiconductor. Above 341 K, it has metallic properties. VO₂ is highly transparent in the infrared spectral band between 2.5 and 11.5 μm, below its transition temperature. The metallic phase at high temperatures, however, strongly attenuates incident electromagnetic radiation at all frequencies [2]. These dramatic changes in the physical properties of VO₂ allow application in optical switching devices, optical recording devices, infrared sensors, switchable/tunable microwave devices, un-cooled microbolometers, and energy efficient smart windows for buildings [3–5].

The desired properties of VO₂ thin films are high resistance and reflectance change during phase transition and a narrow hysteresis width. It has been proven that using single crystal substrates is effective to obtain VO₂ thin films with a large electrical and optical change during phase transition and a narrow hysteresis width because metal-insulator domain wall propagation of highly oriented VO₂ is faster. Orientation control is an interesting topic in thin film growth; highly oriented VO₂ films have been obtained on

sapphire and TiO₂ single crystals [6,7]. However, single crystal substrates are expensive and difficult to prepare on a large scale. These aspects impede application in smart windows. The phase transition properties of VO₂ thin films deposited on various substrates reported in the literature are shown in Table 1. As can be seen, (020) oriented VO₂ thin film shows better metal-insulator transition properties [6–10]. In order to obtain orientation controlled VO₂ thin films on glass substrate, this study tries to find a suitable buffer for VO₂ growth. It has been shown that *c*-axis preferentially orientated ZnO thin films can be prepared on glass substrates [11]. The surface structures of *c*-plane ZnO are similar to sapphire and have a hexagonal plane. This study used a *c*-axis, which is a highly preferentially oriented ZnO thin film, as a buffer layer to control the growth orientation of VO₂ thin films on glass substrates.

2. Experimental details

VO₂ thin films and ZnO buffer were deposited on glass substrates by focusing a frequency-quadrupled Nd-YAG laser (λ = 266 nm). The laser beam, for ablation, was focused by a quartz lens to a fluence of approximately 1.0 J/cm² and directed at an angle of 40° on the targets. The targets used for deposition were pure V metal and ZnO ceramic pellets. These targets were located on multiple target holders, and thus all layers were prepared in a single run process. The glass substrate, placed parallel to the target at a distance of 40 mm, was kept on a substrate holder and rotated during deposition. During deposition, the substrate was heated by an infrared lamp heater.

* Corresponding author.

E-mail address: tewei@ntut.edu.tw (T.-W. Chiu).

Table 1The phase transition properties of VO₂ thin films deposited on various substrates reported in the literature.

Deposition method	Substrate	Preferential orientation of VO ₂	Phase transition temperature (°C)	Hysteresis width (°C)	Thickness (nm)	Ref.
PLD (NA)	VO ₂ single crystal		68	0.1	–	[8]
	TiO ₂ (001)	(002)	96	7 ^a	10–15	[7]
	TiO ₂ (110)	(110)	27	10 ^a	10–15	
PLD (ArF)	Sapphire(0001)	NA	~68	NA	100	
	Sapphire(10–10)	(020)	65(70) ^b	3	NA	[6]
PLD (KrF)	MgO(100)	(020)	55(60) ^b	1	NA	
	Fused quartz	NA	70	2 ^a	500	[9]
Sputtering	Glass	(011)	68	11 ^a	500	
		(011)	60	15	130	
		(011)	60	10	NA	[10]
Alkoxide sol–gel		(011)	56	7	700	
Aqueous sol–gel		(011)	72	11	58	
PLD	Glass	(011)	70	7	58	This study
(Nd-YAG)	ZnO/glass	(020)				

^a Estimated from the figures shown in literature.^b From the figures shown in the literature, the phase transition temperature, midpoint of hysteresis loop, is about 70 and 60 °C, respectively.

The deposition chamber was initially evacuated by a turbo molecular pump to achieve a base pressure of the order of 5×10^{-6} Pa. It was then backfilled with O₂ to obtain a suitable pressure for the deposition of each film. ZnO layers were deposited at a pressure of 1.33 Pa in O₂. During deposition of both ZnO and VO₂, the substrate temperature was kept at 500 °C. The deposition rates of the ZnO and VO₂ thin films were determined by SEM cross section images. The deposition rates of ZnO and VO₂ under 1.33 Pa in O₂ are 10.12 and 0.96 nm/min, respectively.

The crystalline phases of the films were identified with an X-ray diffractometer (XRD) (X' Pert MPD, PANalytical, Netherlands). The electrical resistance of the films was measured by the four-point probe method. During the measurement of electrical resistance the films were heated from room temperature to 80 °C in air using a hotplate. The infrared reflection spectrum of the sample was measured by an FT-IR spectrometer (BRUKER TENSOR27) with a reflectivity measurement accessory (BRUKER A517/Q, beam incident angle 30°). A gold mirror (BRUKER) was used as the reflectance reference, and the background spectra was measured without a sample on the sample holder. A plate shaped heater was placed over the sample to heat the sample to above its transition temperature.

3. Results and discussion

3.1. Dependence on O₂ pressure during deposition

Because of its half-filled d-shell, vanadium possesses a set of valence states and forms a number of oxides such as VO, V₂O₃, VO₂, and V₂O₅. Thus, the forming condition of VO₂ films prepared from V metal target by reactive laser ablation is very sensitive and has a strong dependence on oxygen pressure. First, 100-nm thick ZnO thin films were prepared on glass substrates. The VO₂ films were then deposited continuously on the ZnO film under various O₂ pressures at 500 °C for 60 min. Fig. 1 shows the XRD patterns of the VO₂ films deposited on glass substrates, using a 100-nm thick ZnO buffer with various O₂ partial pressure. ZnO (002) peaks were observed in all O₂ pressures. A peak indicating VO₂ (020) was observed on the film samples deposited under 1.33 Pa and 2.67 Pa, respectively. However, peaks indicating Zn₂V₂O₇ (002) and (004) were also observed. In XRD patterns of film deposited under 4.00 Pa, there appeared peaks indicating Zn₂V₂O₇ (002), (004), and VO₂ (011); under 5.33 Pa and 6.67 Pa, peaks indicating VO₂ (011) and Zn₃(VO₄)₂ (002) were observed. The results indicate that *b*-axis oriented VO₂ film could be prepared under 1.33 Pa in O₂ partial pressure using a ZnO buffer layer. However, some of the deposited VO₂ reacted with ZnO to form *c*-axis preferentially oriented Zn₂V₂O₇.

3.2. Thickness dependence of ZnO buffer layer

To examine the effect of the thickness of a ZnO buffer layer, the thickness of the ZnO film was varied, and VO₂ films were continuously deposited under 1.33 Pa in O₂ partial pressure for 60 min. The XRD patterns of the films deposited, with various thicknesses of ZnO films, are shown in Fig. 2. XRD patterns of the VO₂ film, deposited directly on glass substrate and with 1.6-nm thick ZnO buffer layer, appear to have peaks indicating VO₂ (011). When the ZnO film was thicker than 10 nm, Zn₂V₂O₇ peaks were observed. VO₂ (020) peaks were observed only in the VO₂ film deposited on a 5-nm thick ZnO film. The stack structure of VO₂ films deposited on glass substrate, using ZnO films with various thicknesses, is shown in Fig. 3. With direct deposition of VO₂ films on the glass substrate, polycrystalline VO₂ films were formed on the amorphous substrate. When the ZnO film was only 1.6 nm, the glass surface was not wholly covered; the deposited vanadium reacted with ZnO to form another compound, possibly Zn₂V₂O₇, and some polycrystalline VO₂. In this case, only small VO₂ (011) peaks were observed.

When the ZnO buffer layer was as thick as 5 nm, only peaks indicating *b*-axis oriented VO₂ were observed in the XRD pattern. The broad peak of the glass substrate may have hidden the small fraction of Zn₂V₂O₇ peak. Peaks indicating VO₂ (020) and Zn₂V₂O₇

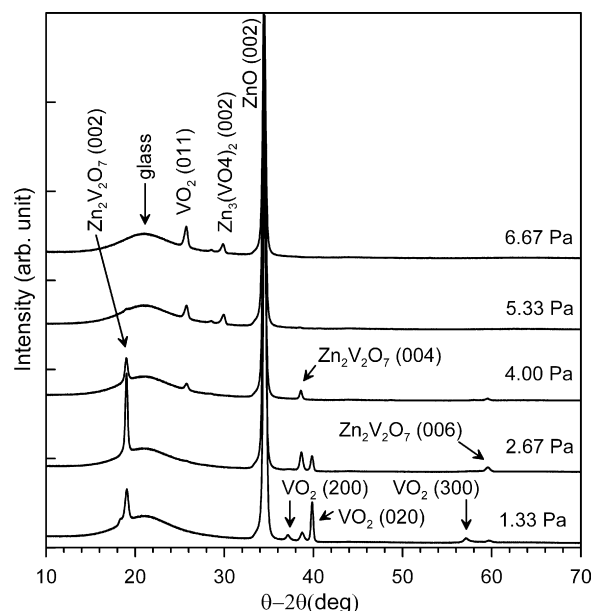


Fig. 1. XRD patterns of the films deposited with 100-nm thick ZnO layer under various O₂ pressures.

Download English Version:

<https://daneshyari.com/en/article/5365506>

Download Persian Version:

<https://daneshyari.com/article/5365506>

[Daneshyari.com](https://daneshyari.com)